Electronic Acknowledgement Receipt				
EFS ID:	1314576			
Application Number:	10816559			
International Application Number:				
Confirmation Number:	1225			
Title of Invention:	Low-K interlayer dielectric wafer grinding			
First Named Inventor/Applicant Name:	Yew Wee Cheong			
Customer Number:	31817			
Filer:	Angela Moore Sagalewicz/Heather Adamson			
Filer Authorized By:	Angela Moore Sagalewicz			
Attorney Docket Number:	111079-136359			
Receipt Date:	15-NOV-2006			
Filing Date:	30-MAR-2004			
Time Stamp:	18:54:16			
Application Type:	Utility			
Payment information:	·			

Payment Information

Submitted with Payment	no	
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1		P18799_response_11_15_0 6.pdf	75001	yes	7

	Multipart Description/PDF mes in .zip description				
	Document Description	Start	End		
	Amendment - After Non-Final Rejection	1	1		
	Claims	2	5		
	Abstract	6	6		
	Applicant Arguments/Remarks Made in an Amendment	7	7		
::					

Multipart Description/PDF files in zin description

Warnings

Information:

Total Files Size (in bytes): 75001

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.